

ASSP

Single Serial Input PLL Frequency Synthesizer

On-Chip 2.5 GHz prescaler

MB15E07L

DESCRIPTION

The Fujitsu MB15E07L is serial input Phase Locked Loop (PLL) frequency synthesizer with a 2.5 GHz prescaler. A 32/33 or a 64/65 can be selected for the prescaler that enables pulse swallow operation.

The latest BiCMOS process technology is used, resultantly a supply current is limited as low as 4.5 mA typ. This operates with a supply voltage of 3.0 V (typ.)

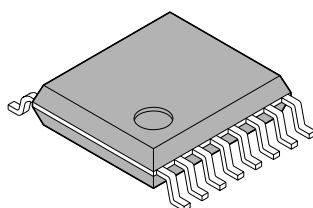
Furthermore, a super charger circuit is included to get a fast tuning as well as low noise performance. As a result of this, MB15E07L is ideally suitable for digital mobile communications, such as GSM (Global System for Mobile Communications).

FEATURES

- High frequency operation: 2.5 GHz max. (@ P = 64/65)
2.0 GHz max. (@ P = 32/33)
- Low power supply voltage: $V_{CC} = 2.7$ to 3.6 V
- Very Low power supply current: $I_{CC} = 4.5$ mA typ. ($V_{CC} = 3$ V)
- Power saving function: $I_{PS} = 0.1$ μ A typ. ($V_{CC} = 3$ V)
- Pulse swallow function: 32/33 or 64/65
- Serial input 14-bit programmable reference divider: $R = 5$ to 16,383
- Serial input 18-bit programmable divider consisting of:
 - Binary 7-bit swallow counter: 0 to 127
 - Binary 11-bit programmable counter: 5 to 2,047
- Wide operating temperature: $T_a = -40$ to $+85^{\circ}\text{C}$
- Plastic 16-pin SSOP package (FPT-16P-M05) and 16-pads BCC package (LCC-16P-M02)

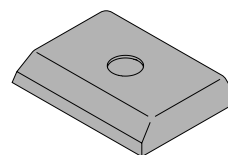
PACKAGES

16-pin, plastic SSOP



(FPT-16P-M05)

16-pads, plastic BCC

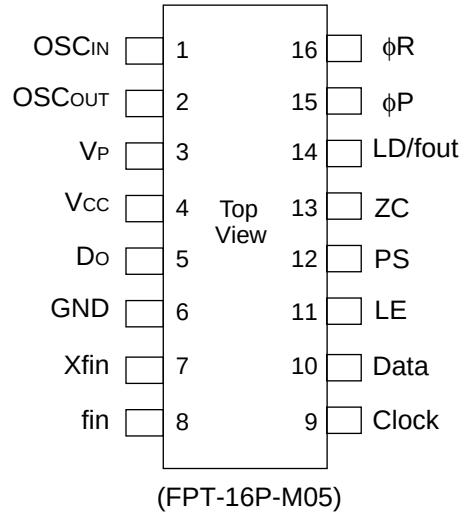


(LCC-16P-M02)

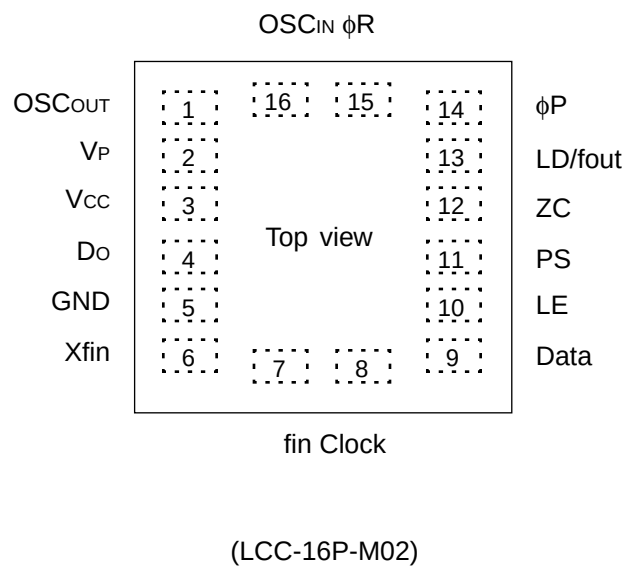
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PIN ASSIGNMENTS

SSOP-16 pin



BCC-16 pads

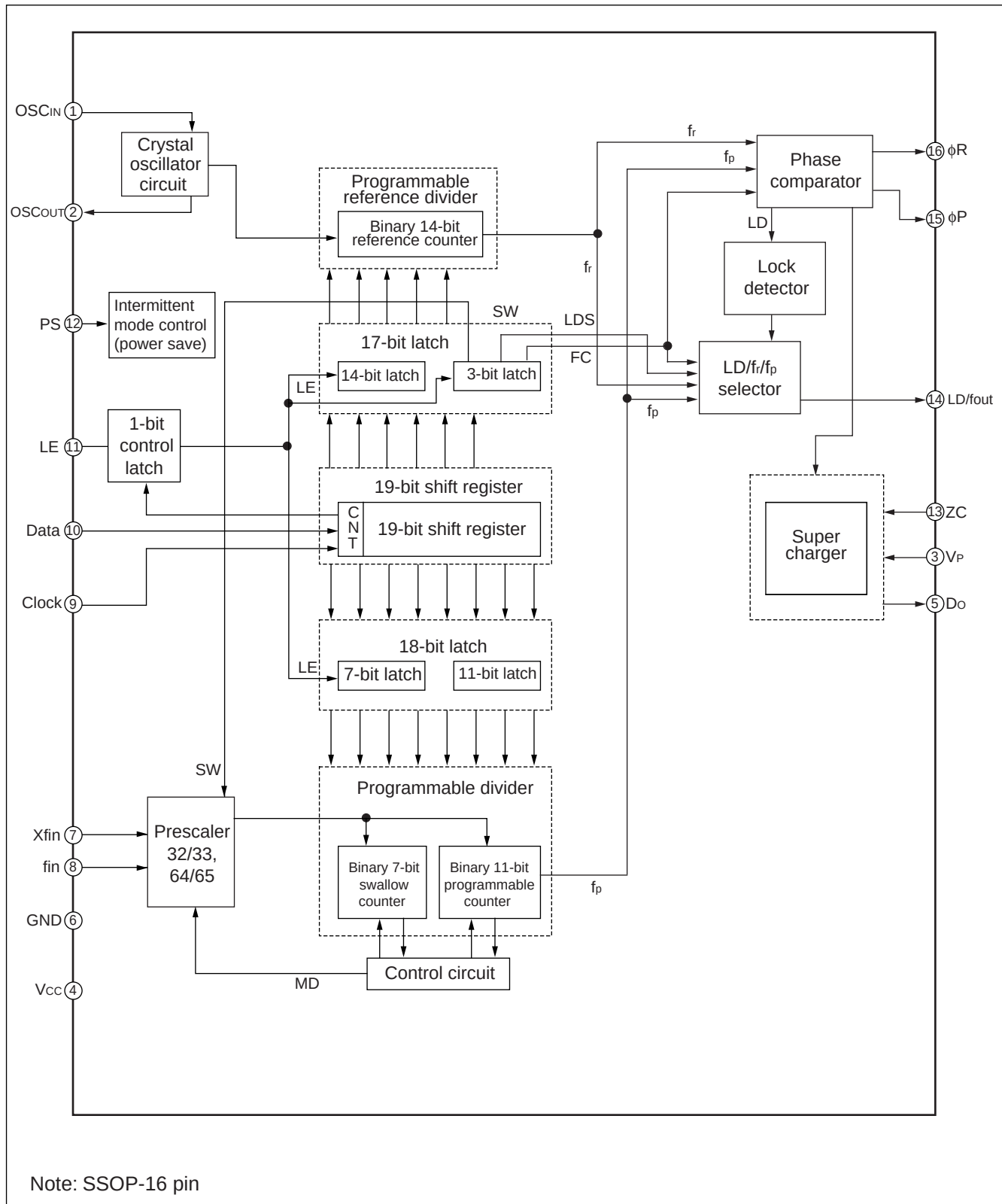


■ PIN DESCRIPTIONS

Pin no.		Pin name	I/O	Descriptions
SSOP-16	BCC-16			
1	16	OSC _{IN}	I	Programmable reference divider input. Oscillator input. Connection for an crystal or a TCXO. TCXO should be connected with a coupling capacitor.
2	1	OSC _{OUT}	O	Oscillator output. Connection for an external crystal.
3	2	V _P	–	Power supply voltage input for the charge pump.
4	3	V _{CC}	–	Power supply voltage input.
5	4	D _O	O	Charge pump output. Phase of the charge pump can be reversed by FC bit.
6	5	GND	–	Ground.
7	6	X _{fin}	I	Prescaler complementary input, and should be grounded via a capacitor.
8	7	fin	I	Prescaler input. Connection with an external VCO should be done with AC coupling.
9	8	Clock	I	Clock input for the 19-bit shift register. Data is shifted into the shift register on the rising edge of the clock. (<i>Open is prohibited.</i>)
10	9	Data	I	Serial data input using binary code. The last bit of the data is a control bit. (<i>Open is prohibited.</i>) Control bit = "H" ; Data is transmitted to the programmable reference counter. Control bit = "L" ; Data is transmitted to the programmable counter.
11	10	LE	I	Load enable signal input (<i>Open is prohibited.</i>) When LE is high, the data in the shift register is transferred to a latch, according to the control bit in the serial data.
12	11	PS	I	Power saving mode control. This pin must be set at "L" at Power-ON. (<i>Open is prohibited.</i>) PS = "H" ; Normal mode PS = "L" ; Power saving mode
13	12	ZC	I	Forced high-impedance control for the charge pump (with internal pull up resistor.) ZC = "H" ; Normal D _O output. ZC = "L" ; D _O becomes high impedance.
14	13	LD/fout	O	Lock detect signal output (LD)/phase comparator monitoring output (fout). The output signal is selected by LDS bit in the serial data. LDS = "H" ; outputs fout (f _r /f _p monitoring output) LDS = "L" ; outputs LD ("H" at locking, "L" at unlocking.)
15	14	φ _P	O	Phase comparator output for an external charge pump. Nch open drain output.
16	15	φ _R	O	Phase comparator output for an external charge pump. CMOS output.

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■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		Unit	Remark
		Min.	Max.		
Power supply voltage	V _{CC}	−0.5	+4.0	V	
	V _P	V _{CC}	+6.0	V	
Input voltage	V _I	−0.5	V _{CC} +0.5	V	
Output voltage	V _O	−0.5	V _{CC} +0.5	V	
Output current	I _O	−10	+10	mA	Except Do output
	I _{do}	−25	+25	mA	Do output
Storage temperature	T _{stg}	−55	+125	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value			Unit	Remark
		Min.	Typ.	Max.		
Power supply voltage	V _{CC}	2.7	3.0	3.6	V	
	V _P	V _{CC}	—	6.0	V	
Input voltage	V _I	GND	—	V _{CC}	V	
Operating temperature	T _a	−40	—	+85	°C	

WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always use semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

Handling Precautions

- This device should be transported and stored in anti-static containers.
- This is a static-sensitive device; take proper anti-ESD precautions. Ensure that personnel and equipment are properly grounded. Cover workbenches with grounded conductive mats.
- Always turn the power supply off before inserting or removing the device from its socket.
- Protect leads with a conductive sheet when handling or transporting PC boards with devices.

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■ ELECTRICAL CHARACTERISTICS

(V_{CC} = 2.7 to 3.6 V, Ta = -40 to +85°C)

Parameter		Symbol	Condition	Value			Unit
				Min.	Typ.	Max.	
Power supply current ^{*1}		I _{CC} ^{*1}	f _{in} = 2500 MHz, f _{osc} = 12 MHz, P = 64/65	—	4.5	—	mA
Power saving current		I _{PS} ^{*2}	ZC = "H" or open	—	—	10	μA
Operating frequency		f _{in}	P = 32/33	100	—	2000	MHz
			P = 64/65	100	—	2500	
Crystal oscillator operating frequency		f _{osc}	min. 500 mV _{P-P}	3	—	40	MHz
Input sensitivity	f _{in} ^{*3}	V _{fin}	50 Ω system (Refer to the test circuit.)	-10	—	+2	dBm
	OSC _{IN} ^{*3}	V _{osc}	—	0.5	—	V _{CC}	V _{P-P}
Input voltage	Data, Clock, LE, PS, ZC	V _{IH}	—	V _{CC} × 0.7	—	—	V
		V _{IL}	—	—	—	V _{CC} × 0.3	
Input current	Data, Clock, LE, PS	I _{IH} ^{*4}	—	-1.0	—	+1.0	μA
		I _{IL} ^{*4}	—	-1.0	—	+1.0	
	ZC	I _{IH} ^{*4}	—	-1.0	—	+1.0	μA
		I _{IL} ^{*4}	Pull up input	-100	—	0	
	OSC _{IN}	I _{IH}	—	0	—	+100	μA
		I _{IL} ^{*4}	—	-100	—	0	
Output voltage	φP	V _{OL}	Open drain output	—	—	0.4	V
	φR, LD/fout	V _{OH}	V _{CC} = 3 V, I _{OH} = -1 mA	V _{CC} - 0.4	—	—	V
		V _{OL}	V _{CC} = 3 V, I _{OL} = 1 mA	—	—	0.4	
	Do	V _{DOH}	V _{CC} = 3 V, I _{OH} = -1 mA	V _P - 0.4	—	—	V
		V _{DOL}	V _{CC} = 3 V, I _{OL} = 1 mA	—	—	0.4	
High impedance cutoff current	Do	I _{OFF}	V _{CC} = 3 V, V _P = 6 V V _{OOP} = GND to 6 V	—	—	3.0	nA
Output current	φP	I _{OL}	Open drain output	1.0	—	—	mA
	φR, LD/fout	I _{OH} ^{*4}	—	-1.0	—	—	mA
		I _{OL}	—	—	—	1.0	
	Do	I _{DOH} ^{*4,5}	V _{CC} = 3 V, V _P = 3 V, V _{DOH} = 2.0 V, Ta = +25°C	-11	—	-6	mA
		I _{DOL} ^{*4}	V _{CC} = 3 V, V _P = 3 V V _{DOL} = 1.0 V, Ta = +25°C	8	—	15	

*1: Conditions; V_{CC} = 3.0 V, Ta = +25°C, in locking state.*2: V_{CC} = 3.0 V, f_{osc} = 12.8 MHz, Ta = +25°C, in power saving mode.

*3: AC coupling with a 1000 pF capacitor connected.

*4: The symbol "—" (minus) means direction of current flow.

*5: Ta = +25°C

■ FUNCTION DESCRIPTIONS

1. Pulse Swallow Function

The divide ratio can be calculated using the following equation:

$$f_{vco} = [(M \times N) + A] \times f_{osc} \div R \quad (A < N)$$

f_{vco} : Output frequency of external voltage controlled oscillator (VCO)

N : Preset divide ratio of binary 11-bit programmable counter (5 to 2,047)

A : Preset divide ratio of binary 7-bit swallow counter ($0 \leq A \leq 127$)

f_{osc} : Output frequency of the reference frequency oscillator

R : Preset divide ratio of binary 14-bit programmable reference counter (5 to 16,383)

M : Preset divide ratio of modules prescaler (32 or 64)

2. Serial Data Input

Serial data is processed using the Data, Clock, and LE pins. Serial data controls the programmable reference divider and the programmable divider separately.

Binary serial data is entered through the Data pin.

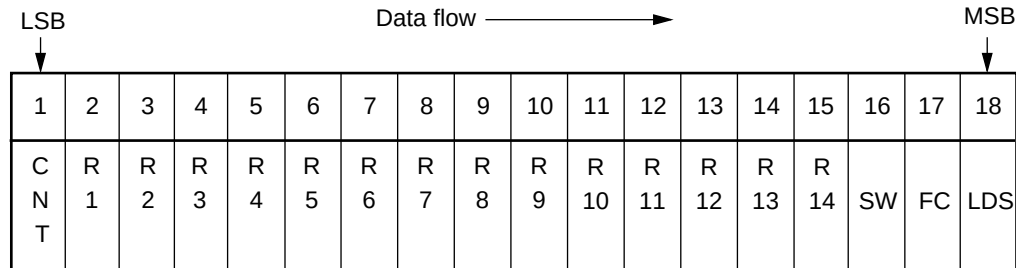
One bit of data is shifted into the shift register on the rising edge of the clock. When the load enable pin is high, stored data is latched according to the control bit data as follows:

Table.1 Control Bit

Control bit (CNT)	Destination of serial data
H	17 bit latch (for the programmable reference divider)
L	18 bit latch (for the programmable divider)

(1) Shift register configuration

Programmable reference counter



CNT : Control bit

R1 to R14 : Divide ratio setting bit for the programmable reference counter (5 to 16,383)

SW : Divide ratio setting bit for the prescaler (32/33 or 64/65)

FC : Phase control bit for the phase comparator

LDS : LD/fout signal select bit

[Table. 1]

[Table. 2]

[Table. 5]

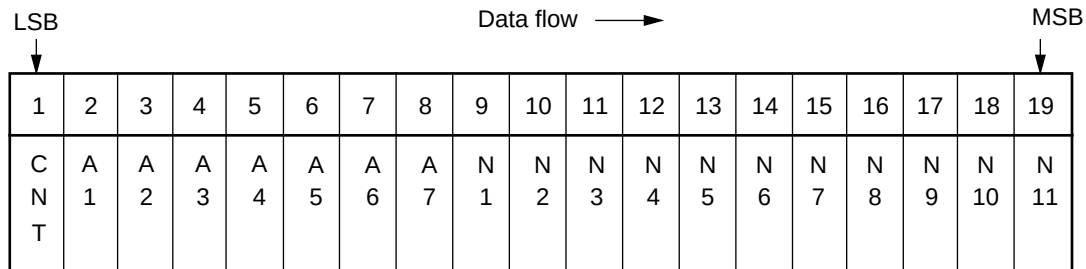
[Table. 7]

[Table. 6]

Note: Start data input with MSB first

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Programmable reference counter



CNT : Control bit

N1 to N11 : Divide ratio setting bits for the programmable counter (5 to 2,047)

A1 to A7 : Divide ratio setting bits for the swallow counter (0 to 127)

[Table. 1]

[Table. 3]

[Table. 4]

Note: Start data input with MSB first

Table.2 Binary 14-bit Programmable Reference Counter Data Setting

Divide ratio (R)	R ₁₄	R ₁₃	R ₁₂	R ₁₁	R ₁₀	R ₉	R ₈	R ₇	R ₆	R ₅	R ₄	R ₃	R ₂	R ₁
5	0	0	0	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	0	0	0	1	1	0
.	.	.	.	.	.	.	.	.	.	.	.	.	.	.
16383	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

Table.3 Binary 11-bit Programmable Counter Data Setting

Divide ratio (N)	N ₁₁	N ₁₀	N ₉	N ₈	N ₇	N ₆	N ₅	N ₄	N ₃	N ₂	N ₁
5	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	1	1	0
.	.	.	.	.	.	.	.	.	.	.	.
2047	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

Table.4 Binary 7-bit Swallow Counter Data Setting

Divide ratio (A)	A 7	A 6	A 5	A 4	A 3	A 2	A 1
0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	1
.	.	.	.	.	.	.	.
127	1	1	1	1	1	1	1

Table.5 Prescaler Data Setting

SW	Prescaler divide ratio
H	32/33
L	64/65

Table.6 LD/fout Output Select Data Setting

LDS	LD/fout output signal
H	fout signal
L	LD signal

(2) Relation between the FC input and phase characteristics

The FC bit changes the phase characteristics of the phase comparator. Both the internal charge pump output level (Do) and the phase comparator output (ϕR , ϕP) are reversed according to the FC bit. Also, the monitor pin (fout) output is controlled by the FC bit. The relationship between the FC bit and each of Do, ϕR , and ϕP is shown below.

Table.7 FC Bit Data Setting (LDS = "H")

	FC = High				FC = Low			
	Do	ϕR	ϕP	LD/fout	Do	ϕR	ϕP	LD/fout
$f_r > f_p$	H	L	L	fout = f_r	L	H	Z*	fout = f_p
$f_r < f_p$	L	H	Z*		H	L	L	
$f_r = f_p$	Z*	L	Z*		Z*	L	Z*	

* : High impedance

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When designing a synthesizer, the FC pin setting depends on the VCO and LPF characteristics.

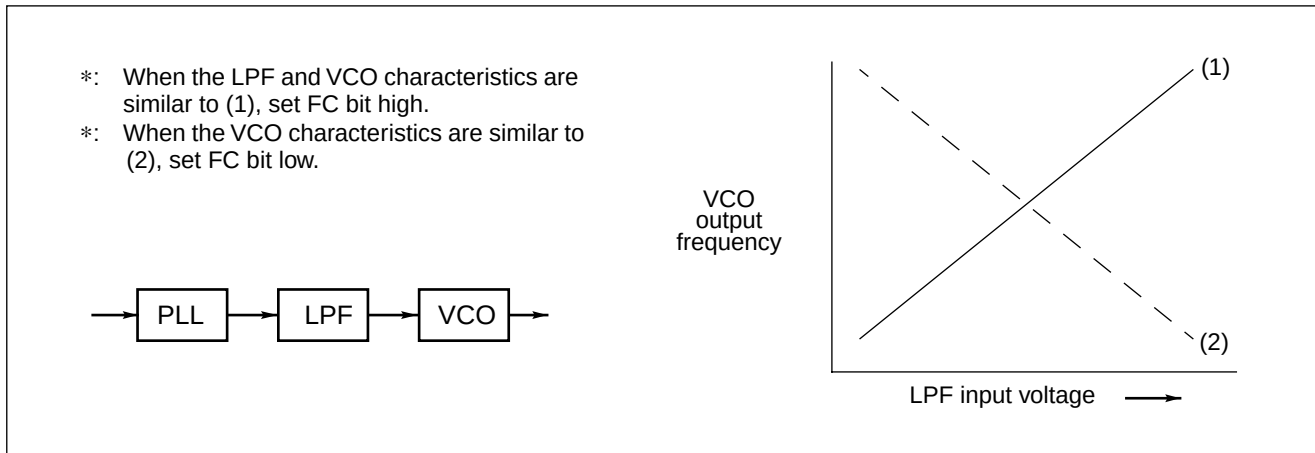


Table.8 PS Pin Setting

PS pin	Status
H	Normal mode
L	Power saving mode

Table.9 ZC Pin Setting

ZC pin	Do output
H	Normal output
L	High impedance

3. Power Saving Mode (Intermittent Mode Control Circuit)

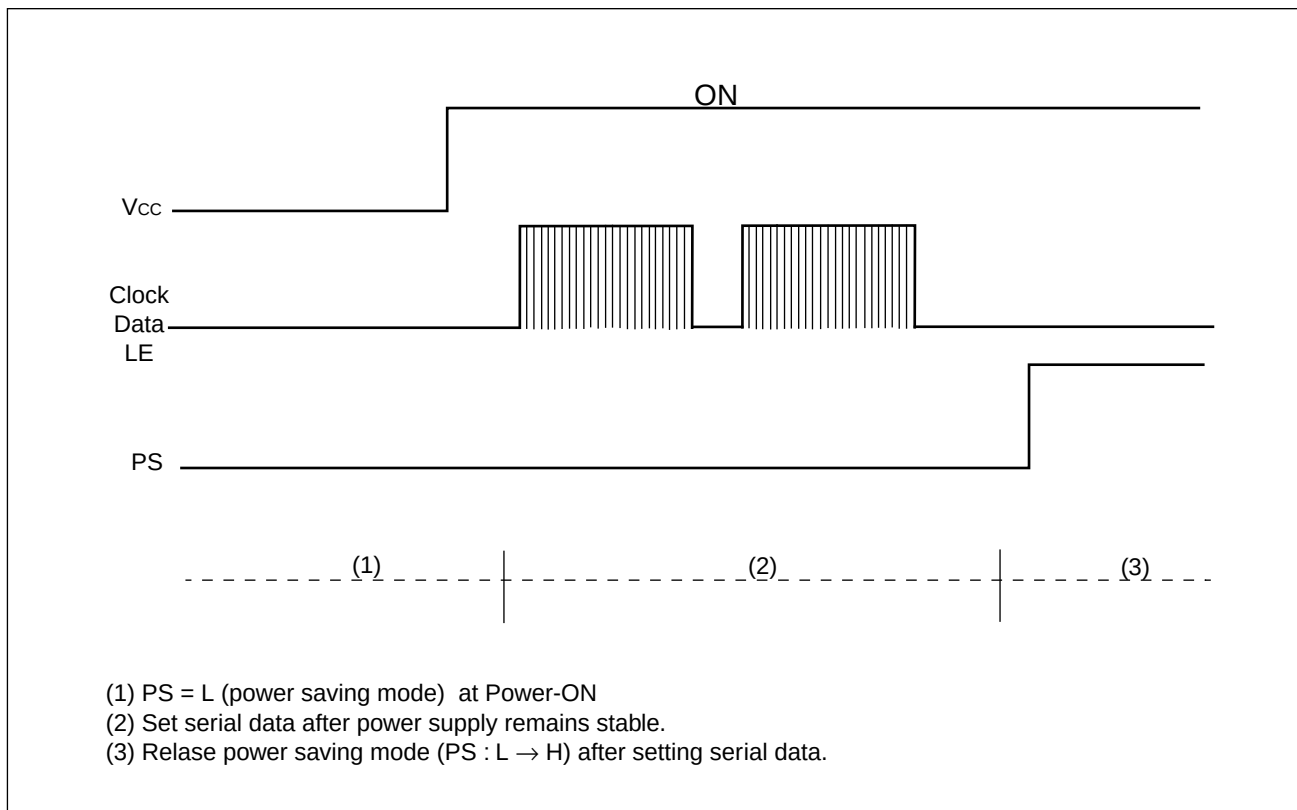
Setting a PS pin to Low, the IC enters into power saving mode resultatly current consumption can be limited to 10 μ A (max.). Setting PS pin to High, power saving mode is released so that the IC works normally.

In addition, the intermittent operation control circuit is included which helps smooth start up from the power saving mode. In general, the power consumption can be saved by the intermittent operation that powering down or waking up the synthesizer. Such case, if the PLL is powered up uncontrolled, the resulting phase comparator output signal is unpredictable due to an undefined phase relation between reference frequency (f_r) and comparison frequency (f_p) and may in the worst case take longer time for lock up of the loop.

To prevent this, the intermittent operation control circuit enforces a limited error signal output of the phase detector during power up, thus keeping the loop locked.

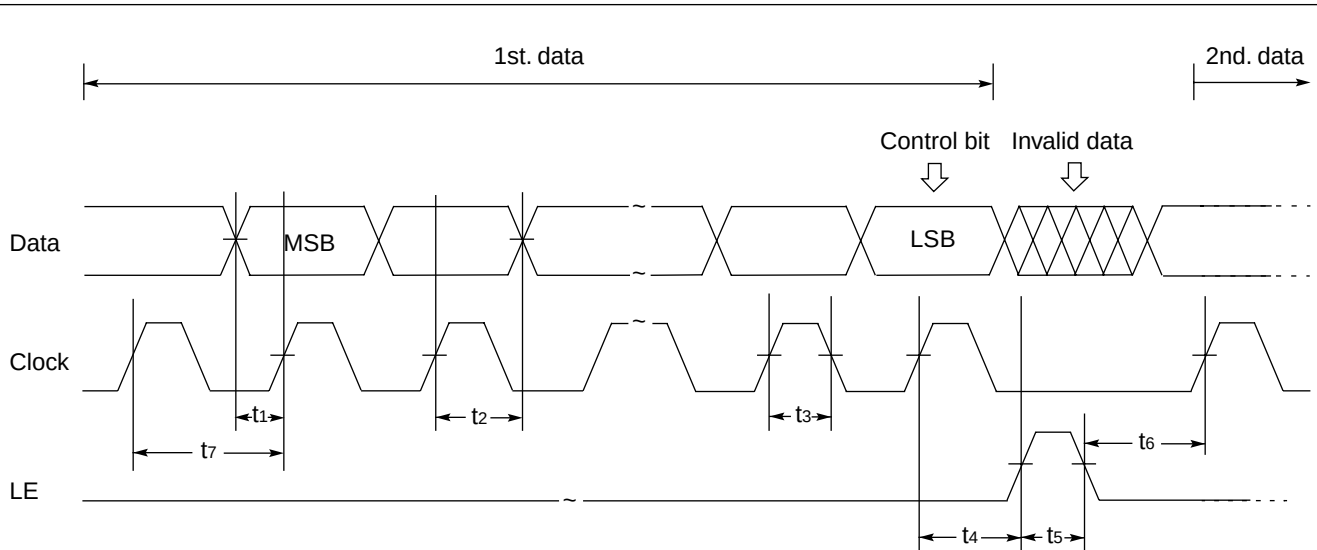
During the power saving mode, the corresponding section except for indispensable circuit for the power saving function stops working, then current consumption is reduced to 10 μ A (max.).

- Note:
- While the power saving mode is executed, ZC pin should be set at "H" or open. If ZC is set at "L" during power saving mode, approximately 10 μ A current flows.
 - PS pin must be set "L" at Power-ON.
 - The power saving mode can be released (PS : L $\rightarrow$ H) 1 μ s later after power supply remains stable.
 - During the power saving mode, it is possible to input the serial data.



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4. Serial Data Input Timing

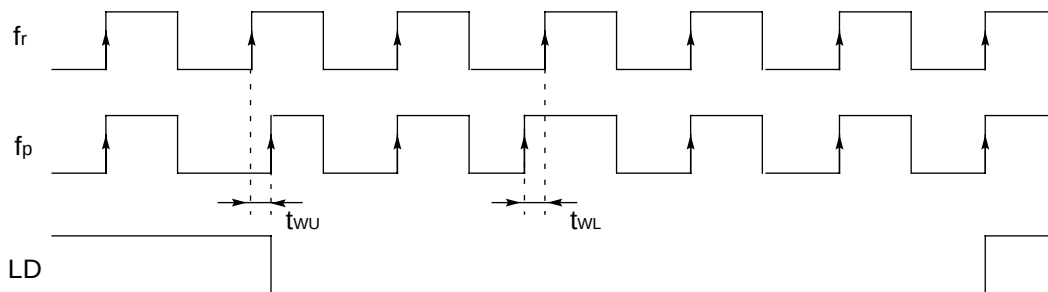


On rising edge of the clock, one bit of the data is transferred into the shift register.

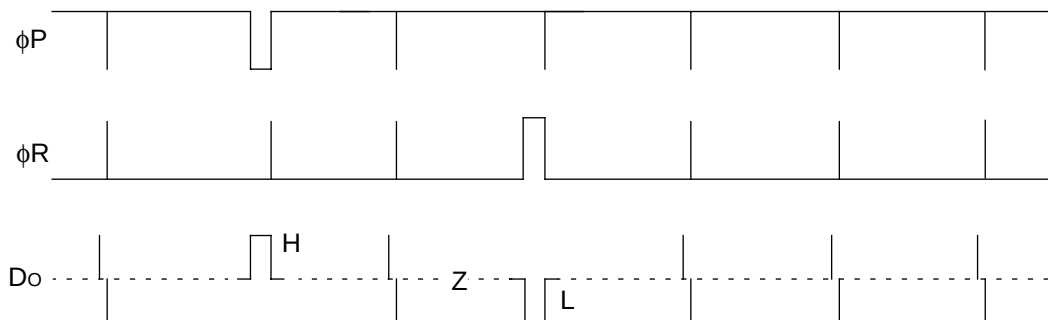
Parameter	Min.	Typ.	Max.	Unit
t ₁	20	—	—	ns
t ₂	20	—	—	ns
t ₃	30	—	—	ns
t ₄	30	—	—	ns

Parameter	Min.	Typ.	Max.	Unit
t ₅	100	—	—	ns
t ₆	20	—	—	ns
t ₇	100	—	—	ns

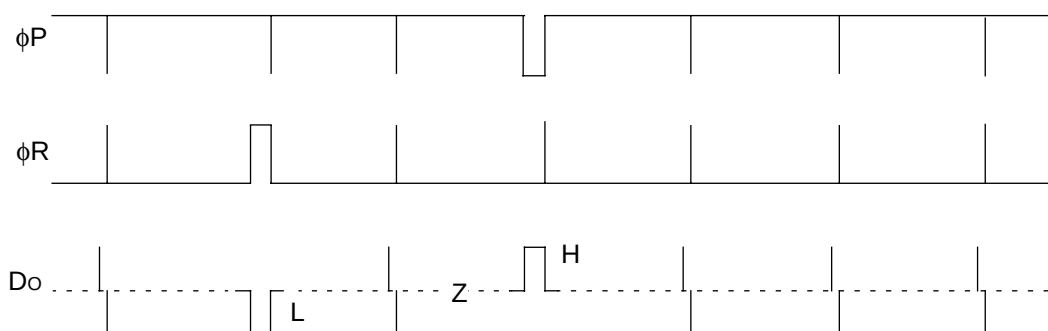
■ PHASE COMPARATOR OUTPUT WAVEFORM



[FC = "H"]



[FC = "L"]

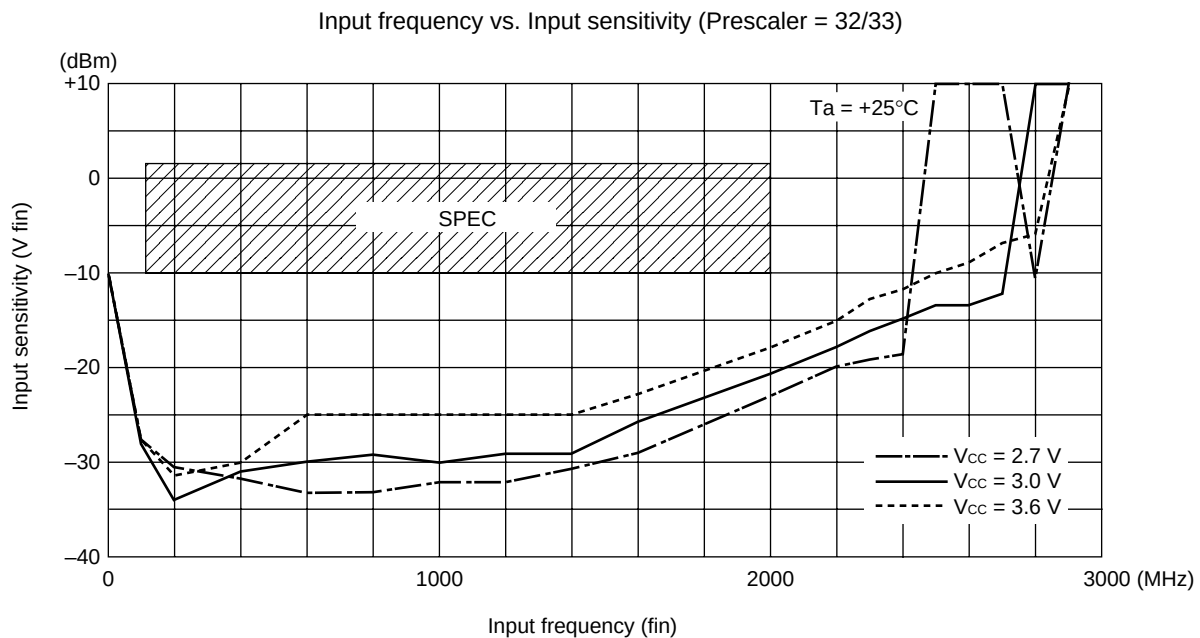
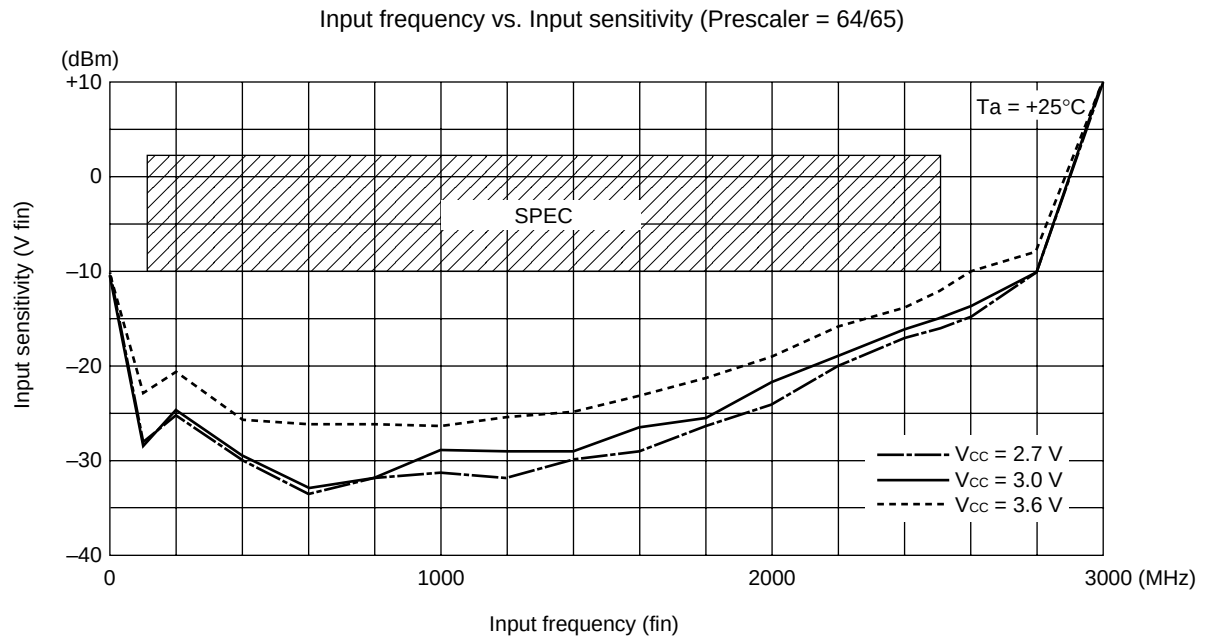


- Notes:
1. Phase error detection range: -2π to $+2\pi$
 2. Pulses on Do output signal during locked state are output to prevent dead zone.
 3. LD output becomes low when phase is t_{wu} or more. LD output becomes high when phase error is t_{wl} or less and continues to be so for three cycles or more.
 4. t_{wu} and t_{wl} depend on OSC_{IN} input frequency.
 $t_{wu} \geq 4/f_{osc}$ (e. g. $t_{wu} \geq 312.5$ ns, $f_{osc} = 12.8$ MHz)
 $t_{wl} \leq 8/f_{osc}$ (e. g. $t_{wl} \leq 625.0$ ns, $f_{osc} = 12.8$ MHz)
 5. LD becomes high during the power saving mode ($PS = "L"$.)

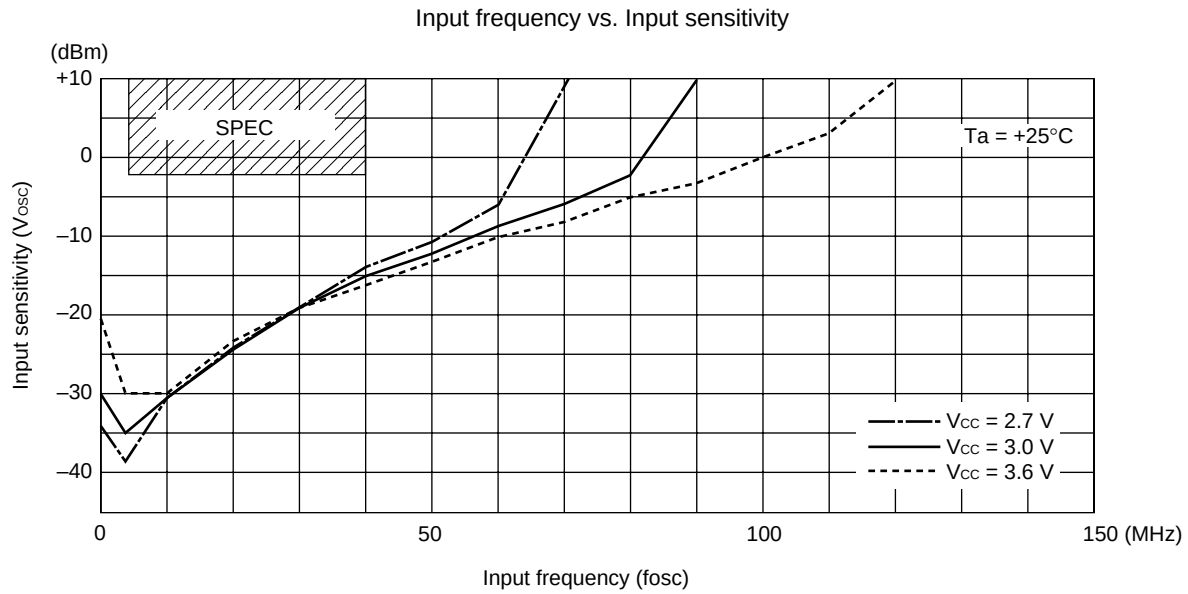
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■ TYPICAL CHARACTERISTICS

1. fin Input Sensitivity

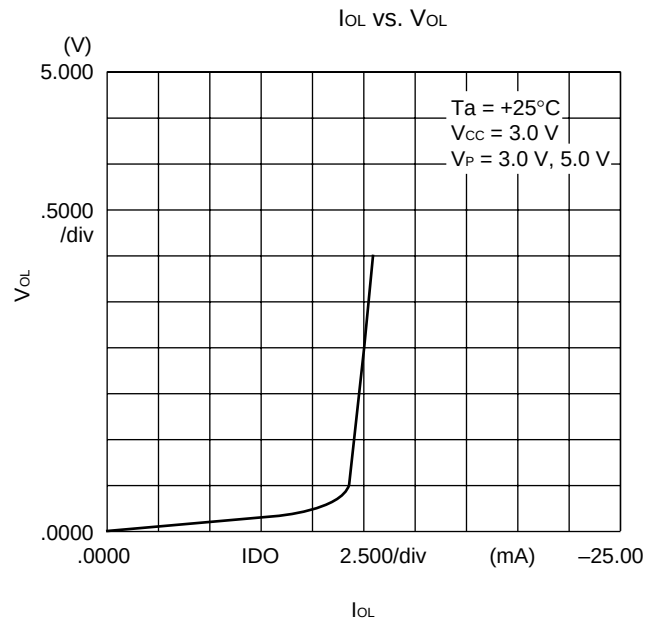
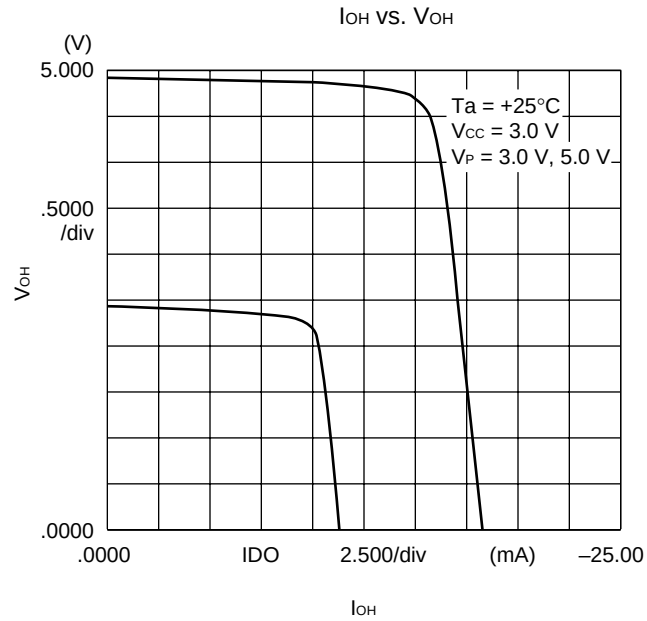


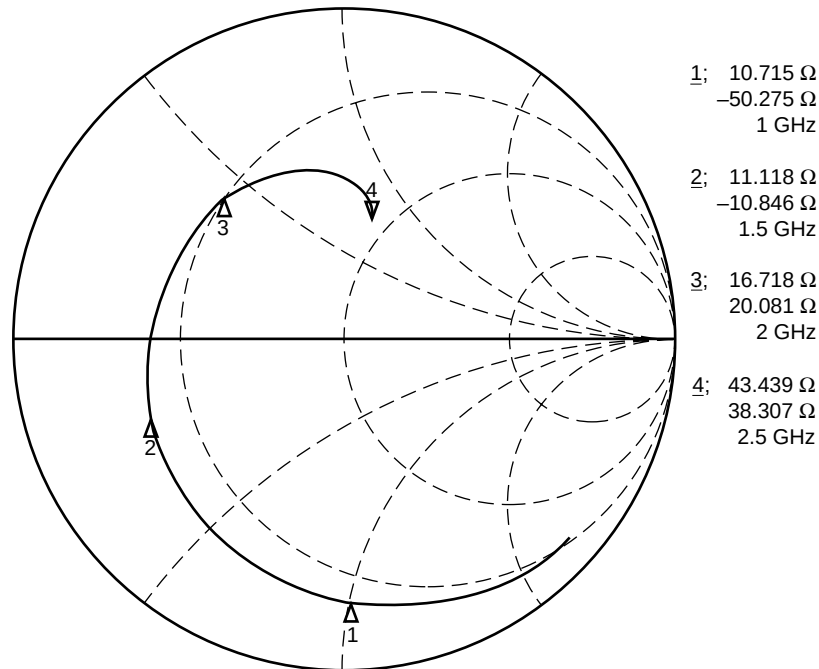
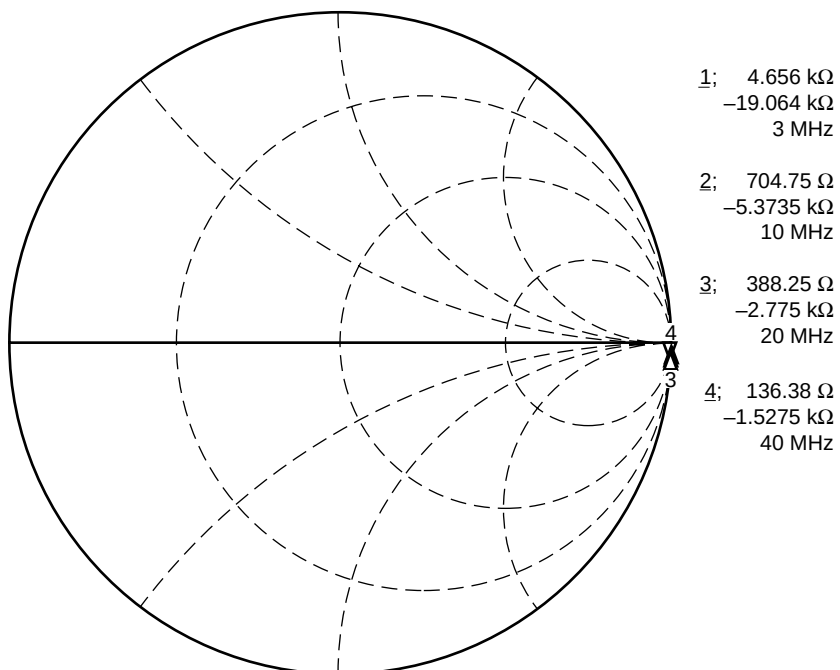
2. OSC_{IN} Input Sensitivity



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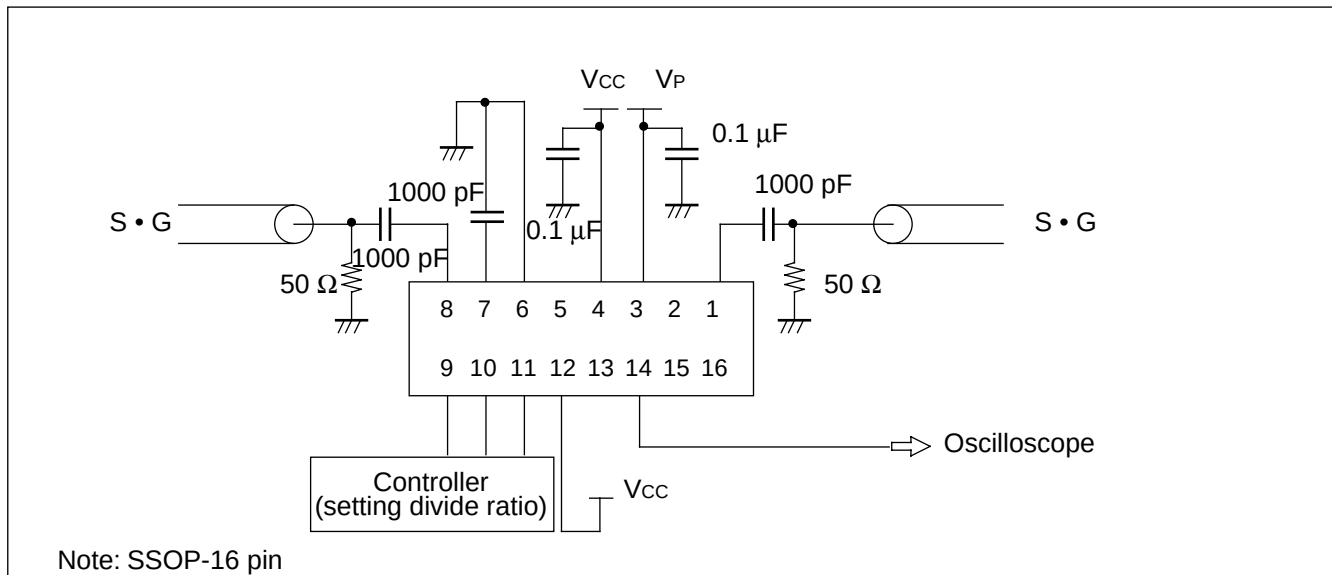
3. Do Output Current



4. fin Input Impedance**5. OSC_{IN} Input Impedance**

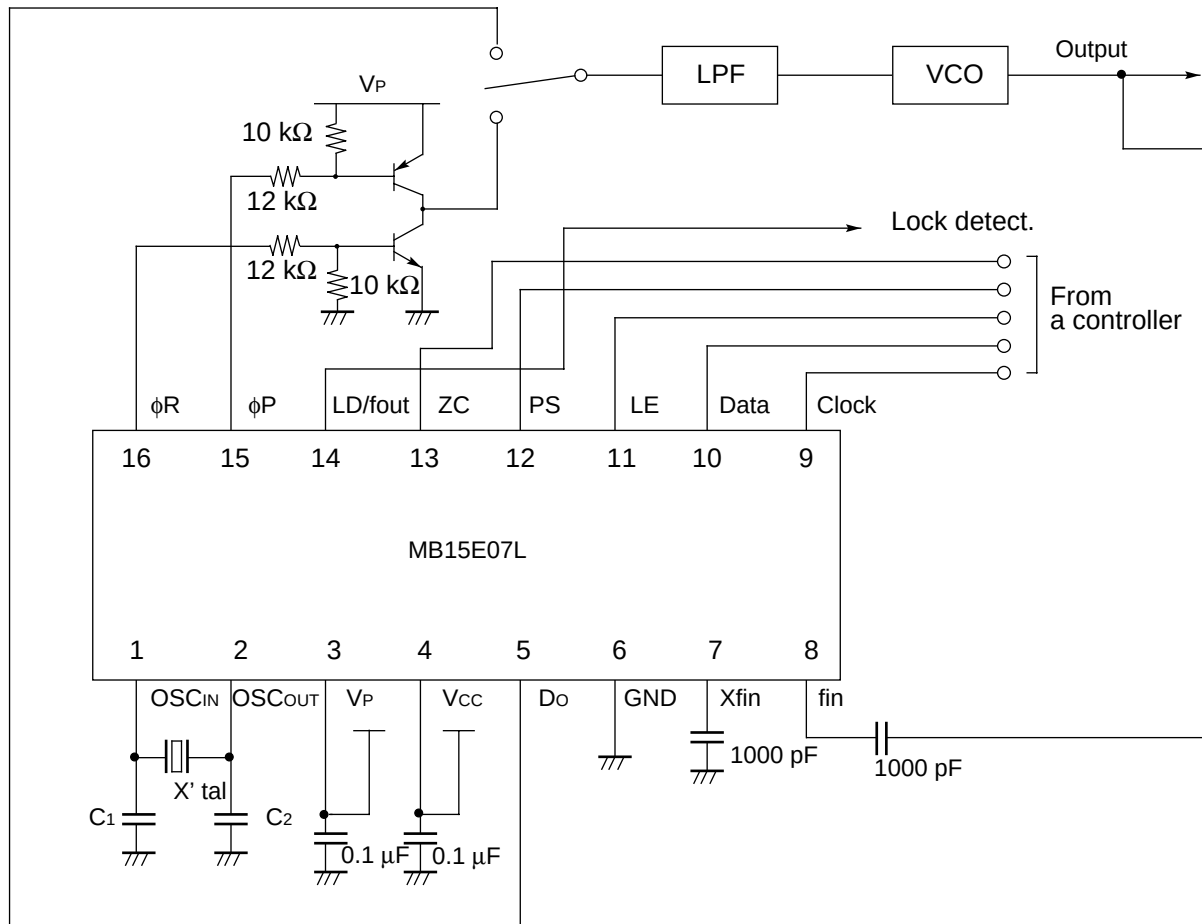
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■ TEST CIRCUIT (FOR MEASURING INPUT SENSITIVITY f_{in}/OSC_{IN})



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APPLICATION EXAMPLE



C₁, C₂: Depend on the crystal parameters

V_P: 6V max.

Note: SSOP-16 pin

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■ ORDERING INFORMATION

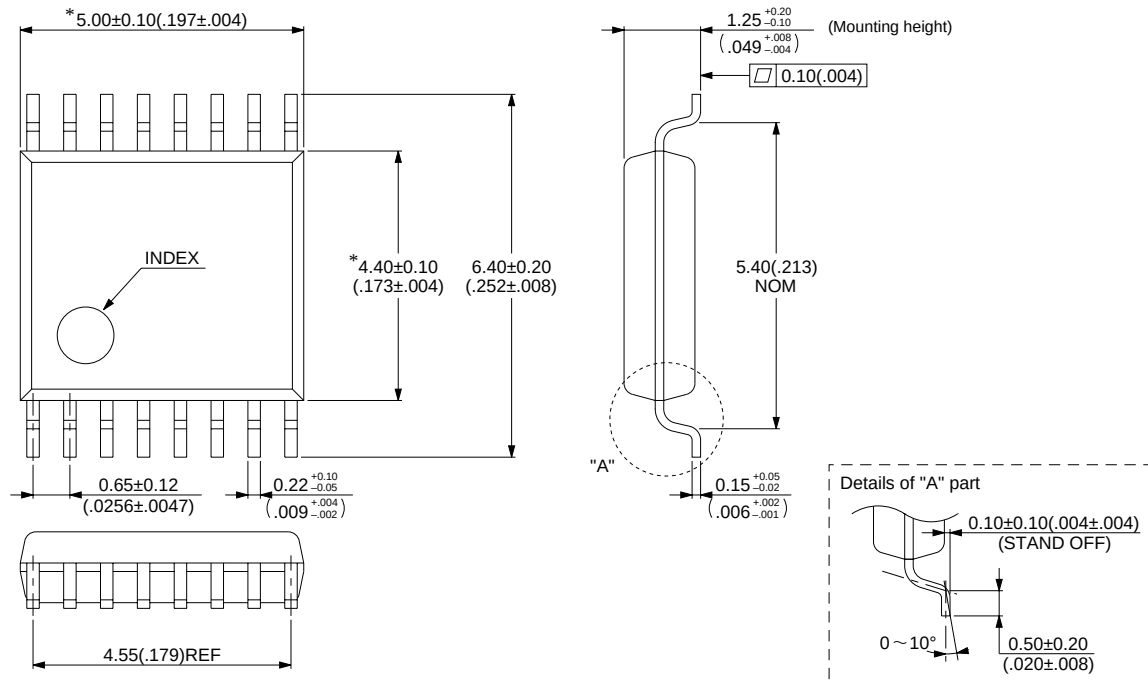
Part number	Package	Remarks
MB15E07LPFV1	16-pin, plastic SSOP (FPT-16P-M05)	
MB15E07LPV	16-pads, plastic BCC (LCC-16P-M02)	

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■ PACKAGE DIMENSIONS

16-pin, plastic SSOP
(FPT-16P-M05)

* : These dimensions do not include resin protrusion.



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Dimensions in mm (inches)

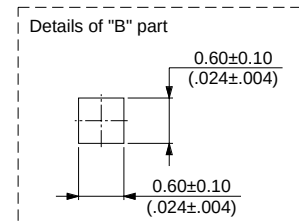
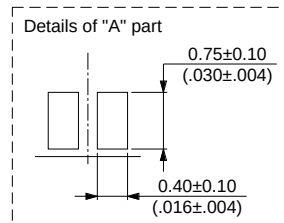
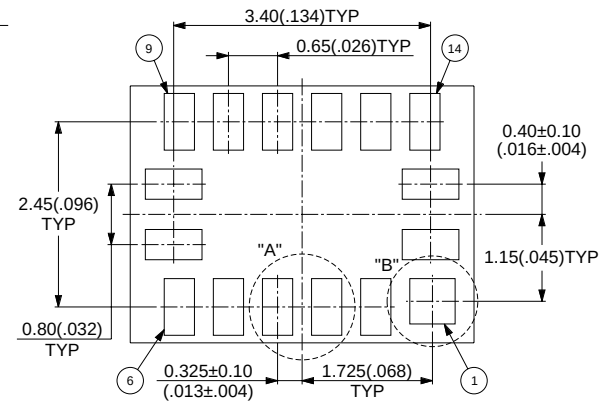
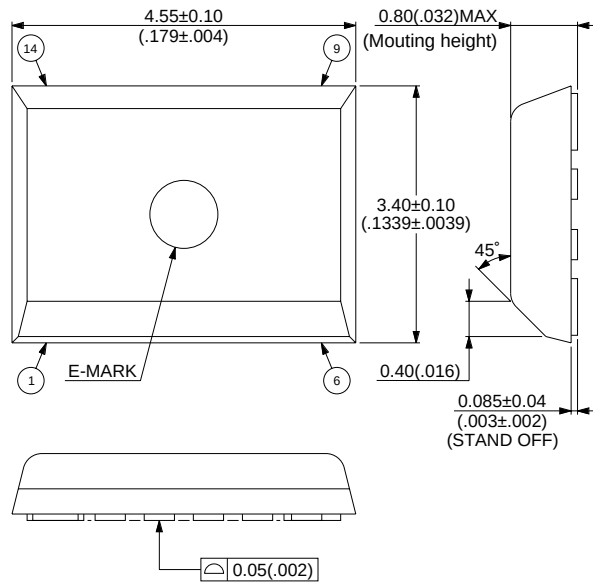
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16-pins, plastic BCC
(LCC-16P-M02)

* : These dimensions do not include resin protrusion.



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Dimensions in mm (inches)

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